# **5 V ECL Coaxial Cable Driver**

#### Description

The MC10EL89 is a differential fanout gate specifically designed to drive coaxial cables. The device is especially useful in Digital Video Broadcasting applications; for this application, since the system is polarity free, each output can be used as an independent driver. The driver boasts a gain of approximately 40 and produces output swings twice as large as a standard ECL output. When driving a coaxial cable, proper termination is required at both ends of the line to minimize signal loss. The 1.6 V output swings allow for termination at both ends of the cable, while maintaining the required 800 mV swing at the receiving end of the cable. Because of the larger output swings, the device cannot be terminated into the standard -2.0 V. All of the DC parameters are tested with a 50  $\Omega$  to -3.0 V load. The driver accepts a standard differential ECL input and can run off of the Digital Video Broadcast standard -5.0 V supply.

#### Features

- 375 ps Propagation Delay
- 1.6 V Output Swings
- PECL Mode Operating Range:
  - $V_{CC} = 4.2 \text{ V}$  to 5.7 V with  $V_{EE} = 0 \text{ V}$
- NECL Mode Operating Range:
  - $V_{CC} = 0$  V with  $V_{EE} = -4.2$  V to -5.7 V
- Internal Input Pulldown Resistors
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant

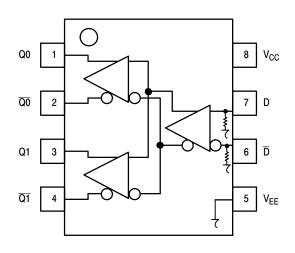


Figure 1. Logic Diagram and Pinout Assignment



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SOIC-8 NB D SUFFIX CASE 751-07

#### **MARKING DIAGRAMS\***

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1	H	H	H	H

= Assembly Locat	ion
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=	Wafer	Lot
=	vvalei	LU

= Year

A L

Y

- W = Work Week
- M = Date Code
  - = Pb-Free Package

(Note: Microdot may be in either location)

\*For additional marking information, refer to Application Note <u>AND8002/D</u>.

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MC10EL89DG	SOIC-8 (Pb-Free)	98 Units/Tube
MC10EL89DR2G	SOIC-8 (Pb-Free)	2500/Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

#### Table 1. PIN DESCRIPTION

PIN	Function			
D, D	ECL Data Inputs			
Q0, <u>Q0;</u> Q1, <u>Q1</u>	ECL Data Outputs (1.6 V <sub>pp</sub> )			
V <sub>CC</sub>	Positive Supply			
V <sub>EE</sub>	Negative Supply			

#### **Table 2. ATTRIBUTES**

Characteristics	Value
Internal Input Pulldown Resistor	50 KΩ
Internal Input Pullup Resistor	N/A
ESD Protection Human Body Model Machine Model	> 2 kV > 100 V
Moisture Sensitivity, Indefinite Time Out of Drypack (Note 1)	Level 1
Flammability Rating Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in
Transistor Count	31
Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test	

1. For additional information, see Application Note AND8003/D.

### **Table 3. MAXIMUM RATINGS**

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V <sub>CC</sub>	PECL Mode Power Supply	V <sub>EE</sub> = 0 V		8	V
V <sub>EE</sub>	NECL Mode Power Supply	V <sub>CC</sub> = 0 V		-8	V
VI	PECL Mode Input Voltage NECL Mode Input Voltage	V <sub>EE</sub> = 0 V V <sub>CC</sub> = 0 V	$\begin{array}{l} V_I \leq V_{CC} \\ V_I \geq V_{EE} \end{array}$	6 6	V
l <sub>out</sub>	Output Current	Continuous Surge		50 100	mA
T <sub>A</sub>	Operating Temperature Range			-40 to +85	°C
T <sub>stg</sub>	Storage Temperature Range			-65 to +150	°C
$\theta_{JA}$	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	SOIC-8	190 130	°C/W
θJC	Thermal Resistance (Junction-to-Case)	Standard Board	SOIC-8	41 to 44	°C/W
T <sub>sol</sub>	Wave Solder (Pb-Free)	<2 to 3 sec @ 260°C		265	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. JEDEC standard multilayer board – 2S2P (2 signal, 2 power)

			-40°C		25°C			85°C				
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit	
I <sub>EE</sub>	Power Supply Current		23	28		23	28		23	28	mA	
V <sub>OH</sub>	Output HIGH Voltage (Note 2)	3.77	3.90	4.02	3.87	3.98	4.10	3.94	4.04	4.19	V	
V <sub>OL</sub>	Output LOW Voltage (Note 2)	2.10	2.28	2.42	2.00	2.30	2.44	1.95	2.33	2.49	V	
V <sub>IH</sub>	Input HIGH Voltage (Single-Ended)	3770		4110	3870		4190	3940		4280	mV	
VIL	Input LOW Voltage (Single-Ended)	3050		3500	3050		3520	3050		3555	mV	
VIHCMR	Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 3)	2.5		4.6	2.5		4.6	2.5		4.6	V	
I <sub>IH</sub>	Input HIGH Current		70	150		50	150		40	150	μA	
Ι <sub>ΙL</sub>	Input LOW Current	0.5	50		0.5	30		0.3	25		μA	

#### Table 4. 10EL SERIES PECL DC CHARACTERISTICS (V<sub>CC</sub> = 5.0 V; V<sub>EE</sub> = 0.0 V (Note 1))

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

1. Input and output parameters vary 1:1 with V<sub>CC</sub>. V<sub>EE</sub> can vary +0.25 V / –0.5 V.

2. Outputs are terminated through a 50  $\Omega$  resistor to V<sub>CC</sub> – 3.0 V.

3. VIHCMR min varies 1:1 with VEE. VIHCMR max varies 1:1 with VCC. The VIHCMR range is referenced to the most positive side of the differential input signal. Normal operation is obtained if the HIGH level falls within the specified range and the peak-to-peak voltage lies between VPPmin and 1 V.

### Table 5. 10EL SERIES NECL DC CHARACTERISTICS (V<sub>CC</sub> = 0.0 V; V<sub>EE</sub> = -5.0 V (Note 1))

		<b>−40°C</b>			25°C						
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I <sub>EE</sub>	Power Supply Current		23	28		23	28		23	28	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 2)	-1.23	-1.10	-0.98	-1.13	-1.02	-0.90	-1.06	-0.96	-0.81	V
V <sub>OL</sub>	Output LOW Voltage (Note 2)	-2.90	-2.72	-2.58	-3.00	-2.70	-2.56	-3.05	-2.67	-2.51	V
V <sub>IH</sub>	Input HIGH Voltage (Single-Ended)	-1230		-890	-1130		-810	-1060		-720	mV
V <sub>IL</sub>	Input LOW Voltage (Single-Ended)	-1950		-1500	-1950		-1480	-1950		-1445	mV
V <sub>IHCMR</sub>	Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 3)	-2.5		-0.4	-2.5		-0.4	-2.5		-0.4	V
I <sub>IH</sub>	Input HIGH Current		70	150		50	150		20	150	μA
۱ <sub>IL</sub>	Input LOW Current	0.5	50		0.5	30		0.3	25		μA

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

1. Input and output parameters vary 1:1 with V<sub>CC</sub>. V<sub>EE</sub> can vary +0.25 V / -0.5 V. 2. Outputs are terminated through a 50  $\Omega$  resistor to V<sub>CC</sub> - 3.0 V.

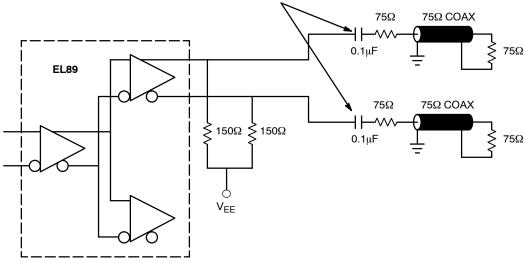
V<sub>IHCMR</sub> min varies 1:1 with V<sub>EE</sub>. V<sub>IHCMR</sub> max varies 1:1 with V<sub>CC</sub>. The V<sub>IHCMR</sub> range is referenced to the most positive side of the differential input signal. Normal operation is obtained if the HIGH level falls within the specified range and the peak-to-peak voltage lies between V<sub>PP</sub>min and 1 V. 3.

			–40°C			25°C			85°C		
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
f <sub>max</sub>	Maximum Toggle Frequency					1.5					Gb/s
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay to Output	200	340	480	260	350	440	310	400	490	ps
t <sub>SKEW</sub>	Within-Device Skew		5	20		5	20		5	20	ps
t <sub>JITTER</sub>	Random Clock Jitter (RMS)		5			5			5		ps
V <sub>PP</sub>	Input Swing (Note 2)	150			150	400		150			mV
t <sub>r</sub> t <sub>f</sub>	Output Rise/Fall Times Q (20% – 80%)	205	330	455	205	330	455	205	330	455	ps

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

1. V<sub>EE</sub> can vary +0.25 V / -0.5 V.

2.  $V_{PP(min)}$  is the minimum input swing for which AC parameters are guaranteed. The device has a DC gain of  $\approx$  40.



DC BLOCKING CAPACITORS

#### Figure 2. EL89 CATV Termination Configuration

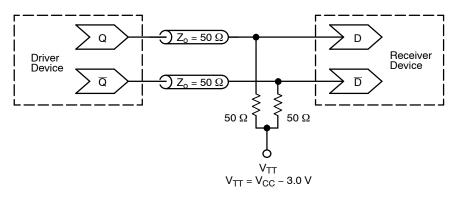
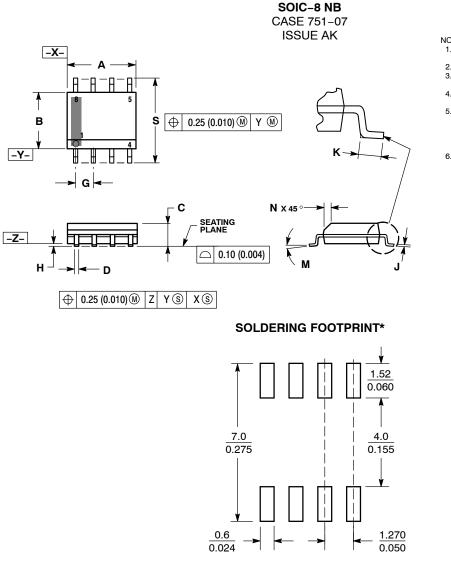


Figure 3. Typical Termination for Output Driver and Device Evaluation (See Application Note <u>AND8020/D</u> – Termination of ECL Logic Devices.)

## **Resource Reference of Application Notes**

AN1405/D	-	ECL Clock Distribution Techniques
AN1406/D	-	Designing with PECL (ECL at +5.0 V)
AN1503/D	-	ECLinPS <sup>™</sup> I/O SPiCE Modeling Kit
AN1504/D	-	Metastability and the ECLinPS Family
AN1568/D	-	Interfacing Between LVDS and ECL
AN1672/D	-	The ECL Translator Guide
AND8001/D	-	Odd Number Counters Design
AND8002/D	-	Marking and Date Codes
AND8020/D	-	Termination of ECL Logic Devices
AND8066/D	-	Interfacing with ECLinPS
AND8090/D	-	AC Characteristics of ECL Devices

#### PACKAGE DIMENSIONS



NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  CONTROLLING DIMENSION: MILLIMETER
- CONTROLLING DIMENSION: MILLIMETER. DIMENSION A AND B DO NOT INCLUDE
- MOLD PROTRUSION. MAXIMUM MOLD PROTRUSION 0.15 (0.006)
- PER SIDE. 5. DIMENSION D DOES NOT INCLUDE DAMBAR
- PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION
- 6. 751–01 THRU 751–06 ARE OBSOLETE. NEW STANDARD IS 751–07.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	4.80	5.00	0.189	0.197
В	3.80	4.00	0.150	0.157
С	1.35	1.75	0.053	0.069
D	0.33	0.51	0.013	0.020
G	1.27 BSC		0.050 BSC	
Н	0.10	0.25	0.004	0.010
J	0.19	0.25	0.007	0.010
κ	0.40	1.27	0.016	0.050
М	0 °	8 °	0 °	8 °
Ν	0.25	0.50	0.010	0.020
S	5.80	6.20	0.228	0.244

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, <u>SOLDERRM/D</u>.

 $\left(\frac{\text{mm}}{\text{inches}}\right)$ 

SCALE 6:1

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